

Electronic Patent Application Fee Transmittal

Application Number:	10542053			
Filing Date:	12-Jul-2005			
Title of Invention:	RESIN FORMING MOLD AND PRODUCTION METHOD FOR THE RESIN FORMING MOLD			
First Named Inventor/Applicant Name:	Yukihiro Yanagawa			
Filer:	Marvin Jay Spivak/Saida Polat			
Attorney Docket Number:	274562US0PCT			
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U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appt Issue fee	1501	1	1400	1400
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